

Description

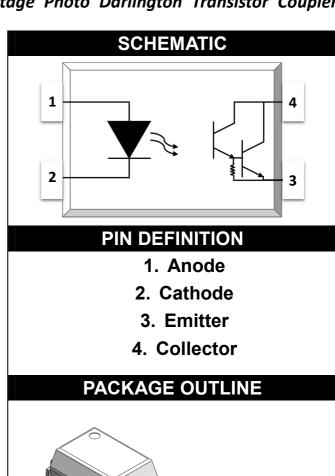
The TD852 series combine an AlGaAs infrared emitting diode as the emitter which is optically coupled to a silicon planar high voltage photo darlington transistor detector in a plastic DIP4 package with different lead forming options. With the robust coplanar double mold structure, TD852 series provide the most stable isolation feature.

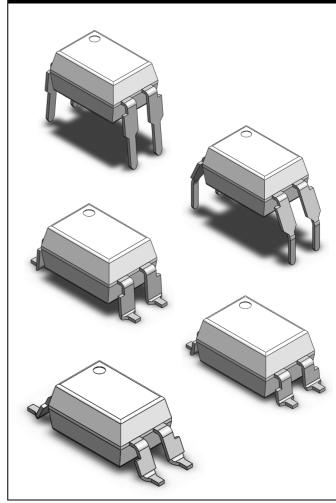
Features

- High isolation 5000 VRMS
- CTR: Min 1000%
- DC input with high voltage darlington transistor output
- Operating temperature range 55 °C to 100 °C
- REACH compliance
- Halogen free
- MSL class 1
- Regulatory Approvals
 - UL UL1577 (Pending Approved)
 - VDE EN60747-5-5(VDE0884-5)
 - CQC GB4943.1, GB8898

Applications

- Switch mode power supplies
- Programmable controllers
- Telecommunication
- DC-Output Module







ABSOLUTE MAXIMUM RATINGS						
PARAMETER	SYMBOL	VALUE	UNIT	NOTE		
INPUT						
Forward Current	lF	60	mA			
Peak Forward Current	I _{FP}	1	Α	1		
Reverse Voltage	VR	6	V			
Input Power Dissipation	Pı	100	mW			
OUTPUT						
Collector - Emitter Voltage	Vceo	350	V			
Emitter - Collector Voltage	VECO	0.1	V			
Collector Current	Ic	150	mA			
Output Power Dissipation	Po	150	mW			
COMMON						
Total Power Dissipation	Ptot	200	mW			
Isolation Voltage	Viso	5000	Vrms	2		
Operating Temperature	Topr	-55~100	°C			
Storage Temperature	Tstg	-55~150	°C			
Soldering Temperature	Tsol	260	°C			

Note 1. 100µs pulse, 100Hz frequency

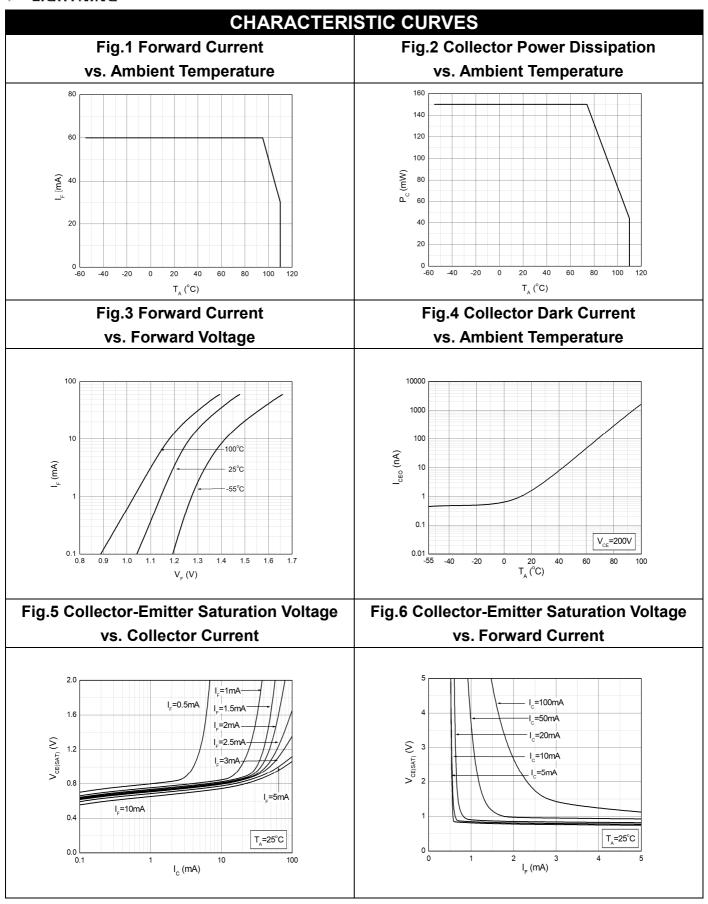
Note 2. AC For 1 Minute, R.H. = $40 \sim 60\%$



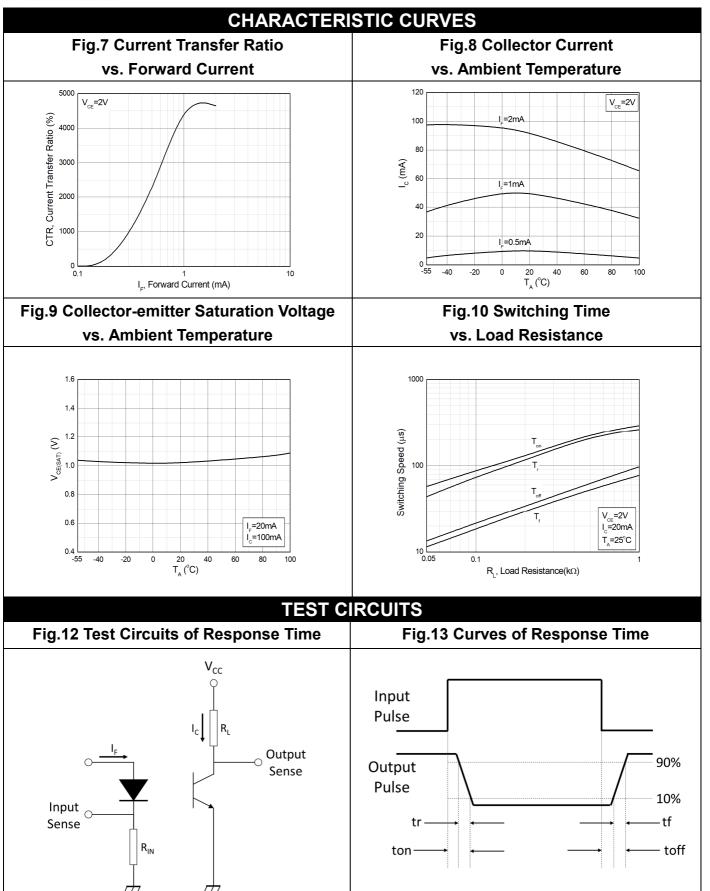
ELECTRICAL OPTICAL CHARACTERISTICS at Ta=25°C							
PARAMETER	SYMBOL	MIN	TYP.	MAX.	UNIT	TEST CONDITION	NOTE
INPUT							
Forward Voltage	VF	-	1.24	1.4	٧	IF=10mA	
Reverse Current	I _R	-	-	10	μΑ	VR=6V	
Input Capacitance	Cin	-	10	-	рF	V=0, f=1kHz	
OUTPUT							
Collector Dark Curren	ICEO	-	-	100	nΑ	VCE=200V, IF=0	
Collector-Emitter Breakdown Voltage	BVceo	350	-	-	V	IC=0.1mA, IF=0	
Emitter-Collector Breakdown Voltage	BVECO	0.1	-	-	V	IE=0.1mA, IF=0	
TRANSFER CHARACTERISTICS							
Current Transfer TD852 Ratio	CTR	1000	1	15000	%	IF=1mA, VCE=2V	
Collector-Emitter Saturation Voltage	VCE(sat)	-	-	1.2	V	IF=20mA, IC=100mA	
Isolation Resistance	Riso	10^12	10^14	-	Ω	DC500V, 40 ~ 60% R.H.	
Floating Capacitance	Сю	-	0.4	-	рF	V=0, f=1MHz	
Response Time (Rise)	tr	-	-	300	μs	VCE=2V, IC=2mA	3
Response Time (Fall)	tf	-	-	100	μs	RL=100Ω	3

Note 3. Fig.12 & Fig.13

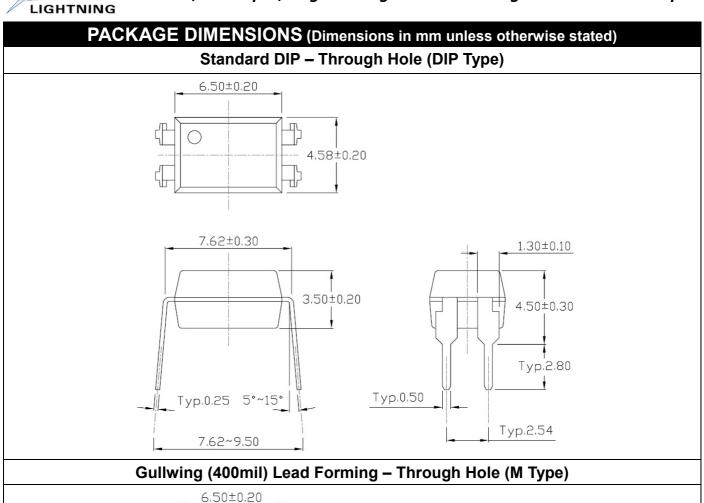


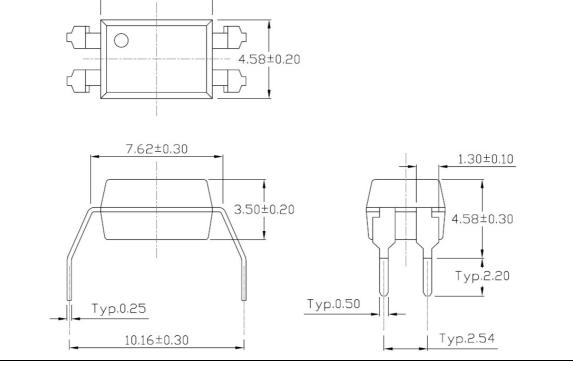






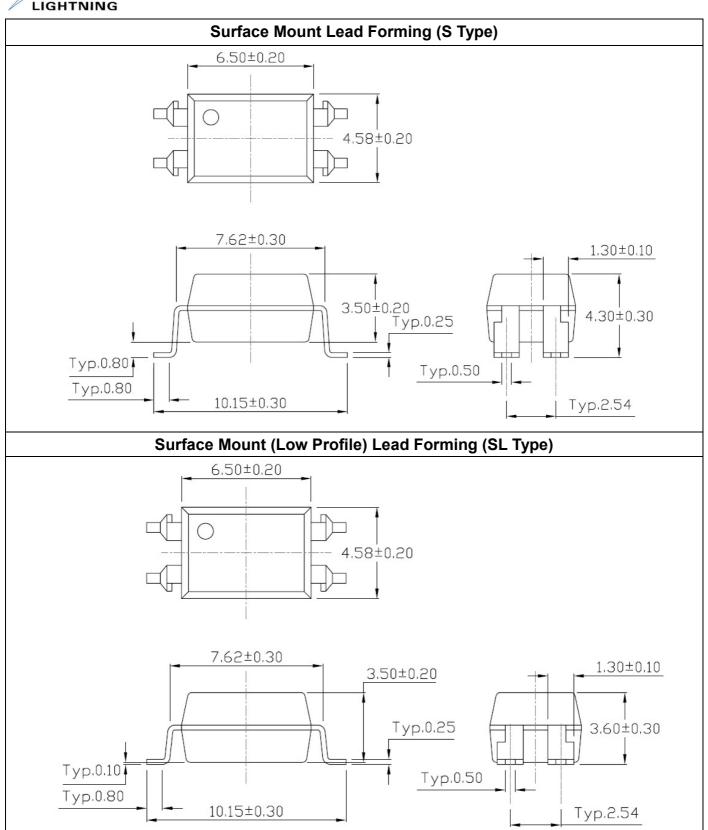






PACKAGE DIMENSIONS (Dimensions in mm unless otherwise stated)

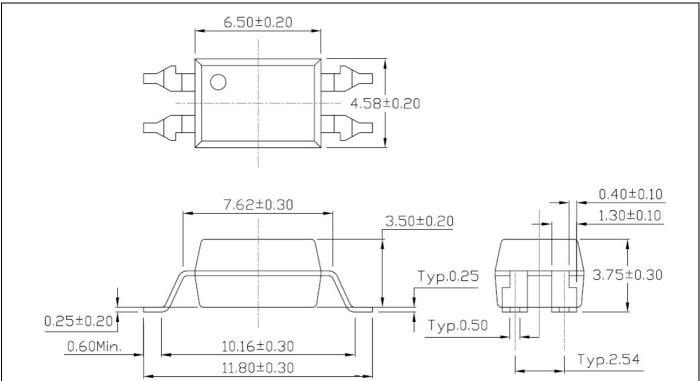




PACKAGE DIMENSIONS (Dimensions in mm unless otherwise stated)

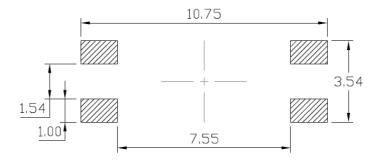
Surface Mount (Gullwing) Lead Forming (SLM Type)



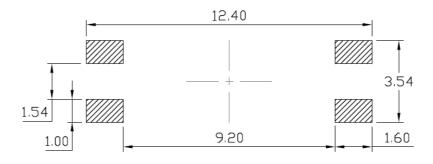


RECOMMENDED SOLDER MASK (Dimensions in mm unless otherwise stated)

Surface Mount Lead Forming & Surface Mount (Low Profile) Lead Forming



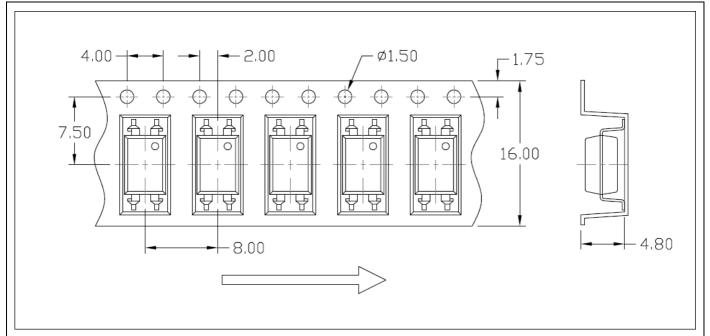
Surface Mount (Gullwing) Lead Forming



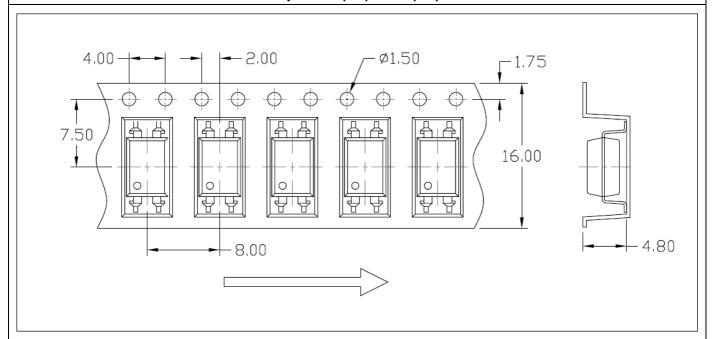
CARRIER TAPE SPECIFICATIONS (Dimensions in mm unless otherwise stated)

Option S(T1) & SL(T1)





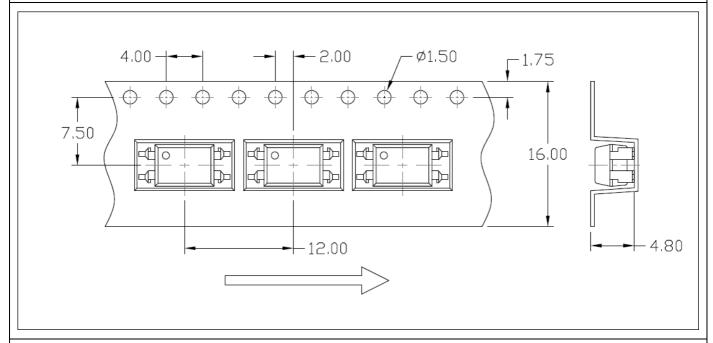
Option S(T2) & SL(T2)



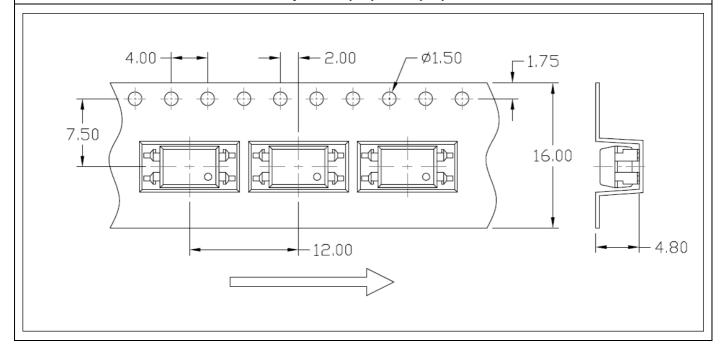


CARRIER TAPE SPECIFICATIONS (Dimensions in mm unless otherwise stated)

Option S(T3) & SL(T3)

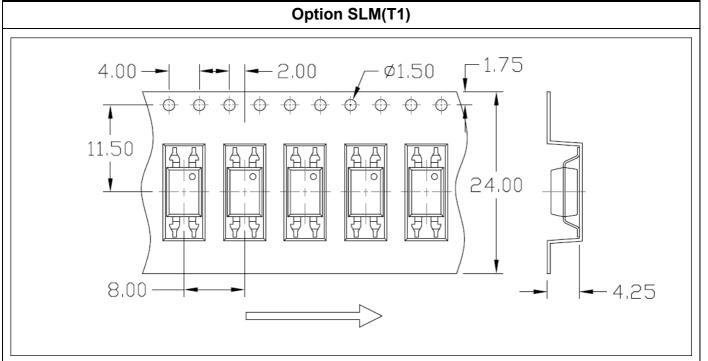


Option S(T4) & SL(T4)

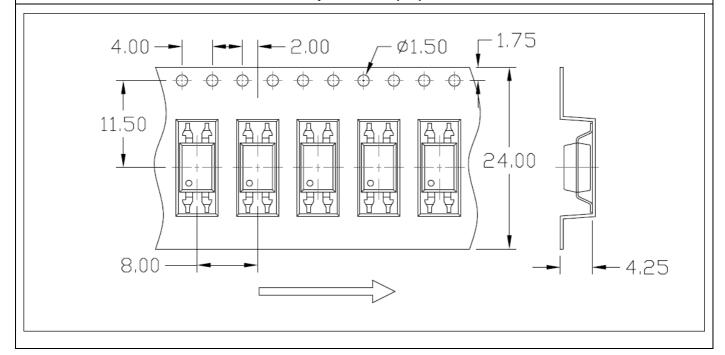




CARRIER TAPE SPECIFICATIONS (Dimensions in mm unless otherwise stated)



Option SLM(T2)





ORDERING AND MARKING INFORMATION

MARKING INFORMATION



TD : Company Abbr.

852 : Part Number

X : CTR Rank

V : VDE Option

Y : Fiscal Year

A : Manufacturing Code

WW : Work Week

ORDERING INFORMATION

TD852(Y)(Z)-FGV

TD – Company Abbr.

852 - Part Number

Y – Lead Form Option (M/S/SL/SLM/None)

Z – Tape and Reel Option (T1/T2/T3/T4)

F – Leadframe Option (F:Iron, None:Copper)

G - Green

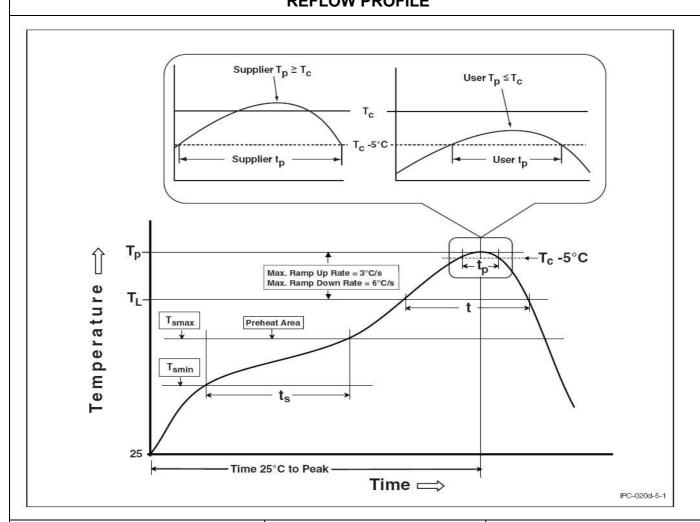
V – VDE Option (V or None)

Packing Quantity

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Option	Description	Quantity		
None	Standard 4 Pin Dip	100 Units/Tube		
М	Gullwing (400mil) Lead Forming	100 Units/Tube		
S(T1)	Surface Mount Lead Forming – With Option 1 Taping	1500 Units/Reel		
S(T2)	Surface Mount Lead Forming – With Option 2 Taping	1500 Units/Reel		
S(T3)	Surface Mount Lead Forming – With Option 3 Taping	1000 Units/Reel		
S(T4)	Surface Mount Lead Forming – With Option 4 Taping	1000 Units/Reel		
SL(T1)	Surface Mount (Low Profile) Lead Forming– With Option 1 Taping	1500 Units/Reel		
SL(T2)	Surface Mount (Low Profile) Lead Forming – With Option 2 Taping	1500 Units/Reel		
SL(T3)	Surface Mount (Low Profile) Lead Forming– With Option 3 Taping	1000 Units/Reel		
SL(T4)	Surface Mount (Low Profile) Lead Forming – With Option 4 Taping	1000 Units/Reel		
SLM(T1)	Surface Mount (Gullwing) Lead Forming– With Option 1 Taping	1500 Units/Reel		
SLM(T2)	Surface Mount (Gullwing) Lead Forming – With Option 2 Taping	1500 Units/Reel		



REFLOW INFORMATION REFLOW PROFILE



Profile Feature	Sn-Pb Assembly Profile	Pb-Free Assembly Profile
Temperature Min. (Tsmin)	100	150°C
Temperature Max. (Tsmax)	150	200°C
Time (ts) from (Tsmin to Tsmax)	60-120 seconds	60-120 seconds
Ramp-up Rate (tL to tP)	3°C/second max.	3°C/second max.
Liquidous Temperature (TL)	183°C	217°C
Time (tL) Maintained Above (TL)	60 – 150 seconds	60 – 150 seconds
Peak Body Package Temperature	235°C +0°C / -5°C	260°C +0°C / -5°C
Time (tP) within 5°C of 260°C	20 seconds	30 seconds
Ramp-down Rate (TP to TL)	6°C/second max	6°C/second max
Time 25°C to Peak Temperature	6 minutes max.	8 minutes max.



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- Please contact LIGHTNING sales agent for special application request.
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 over time. All operating parameters, including typical parameters, must be validated in each
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